

PACKAGE NAME: IL Govt Legal Lake County

District Wide Capital Improvements

The Board of Education of Township High School District 113, Lake County, Illinois is accepting bid proposals for the District Wide Capital Improvements located at Highland Park and Deerfield High School at 433 Vine Ave in Highland Park, IL and 1959 Waukegan Road in Deerfield, IL.

The current Bid Period 4 consists of Asphalt Paving, Site Concrete, and Site Utilities as it relates to the District Wide Capital Improvements. These Scopes of Work will be purchased under one all-encompassing Bid Package.

Prime Trade Agreements for the Work will be assigned to the Construction Manager.

All bids must be accompanied by a Cashier's Check or Bid Bond of ten percent (10%) of the amount of the Base Bid made payable to Township High School District 113. Contractors shall guarantee their submitted Bid Proposal for a ninety (90) day period from the date of Bid Opening. The successful bidder will be required to furnish a Performance and Payment Bond for 100% of the final contract sum. Contractor's Qualifications Statement must be submitted at time of bid or already be on file with Pepper Construction. Compliance with Prevailing Wages for Lake County and all equal employment practices is required.

Please note, Pepper will be hosting a Pre-Bid Walkthrough on Wednesday, February 22, 2023 11:00 AM, beginning at Highland Park High School before moving to Deerfield High School.

Sealed bids must be received by Mr. Brian Ahmer no later than 3:00 PM CST on March 7, 2023, at District 113 Administration Building 1040 Park Avenue West, Highland Park, Illinois 60035 and shall be marked "SEALED BID, Attention Mr. Brian Ahmer".

BIDS WILL ONLY BE ACCEPTED AT THE ADMINISTRATION BUILDING.

There will be a public bid opening immediately following the March 7, 2023, 3:00 PM CST due date/time. For more information and contract documents, please contact Ryan Duddy at Pepper Construction, 847-381-2760.
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